

DATA SHEET

BFG25AW
BFG25AW/X; BFG25AW/XR
NPN 5 GHz wideband transistor

Product specification
File under Discrete Semiconductors, SC14

August 1995

Philips Semiconductors



PHILIPS

NPN 5 GHz wideband transistor

BFG25AW
BFG25AW/X; BFG25AW/XR

FEATURES

- Low current consumption (100 μ A to 1 mA)
- Low noise figure
- Gold metallization ensures excellent reliability.

APPLICATIONS

They are intended for wideband applications in UHF low power amplifiers, such as pocket telephones, paging systems.

DESCRIPTION

NPN silicon planar epitaxial transistors in plastic, 4-pin dual-emitter SOT343 and SOT343R packages.

MARKING

TYPE NUMBER	CODE
BFG25AW	N6
BFG25AW/X	V1
BFG25AW/XR	V3

PINNING

PIN	DESCRIPTION
BFG25AW (see Fig.1)	
1	collector
2	base
3	emitter
4	emitter
BFG25AW/X (see Fig.1)	
1	collector
2	emitter
3	base
4	emitter
BFG25AW/XR (see Fig.2)	
1	collector
2	emitter
3	base
4	emitter

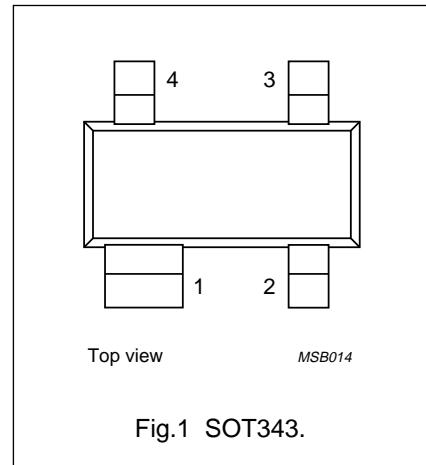


Fig.1 SOT343.

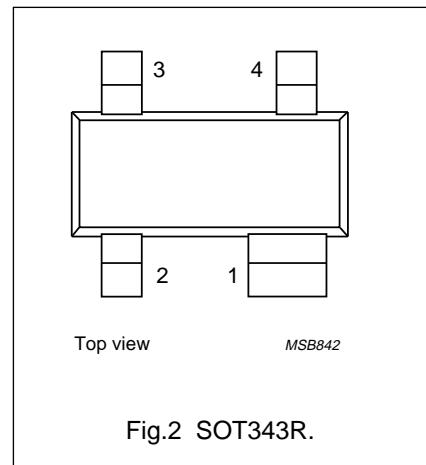


Fig.2 SOT343R.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–	8	V
V_{CEO}	collector-emitter voltage	open base	–	–	5	V
I_C	collector current (DC)		–	–	6.5	mA
P_{tot}	total power dissipation	up to $T_s = 85^\circ\text{C}$	–	–	500	mW
h_{FE}	DC current gain	$I_C = 0.5 \text{ mA}; V_{CE} = 1 \text{ V}$	50	80	200	
C_{re}	feedback capacitance	$I_C = 0; V_{CE} = 1 \text{ V}; f = 1 \text{ MHz}$	–	0.2	0.3	pF
f_T	transition frequency	$I_C = 1 \text{ mA}; V_{CE} = 1 \text{ V}; f = 500 \text{ MHz}; T_{amb} = 25^\circ\text{C}$	3.5	5	–	GHz
G_{UM}	maximum unilateral power gain	$I_C = 0.5 \text{ mA}; V_{CE} = 1 \text{ V}; f = 1 \text{ GHz}; T_{amb} = 25^\circ\text{C}$	–	16	–	dB
F	noise figure	$\Gamma_s = \Gamma_{opt}; I_C = 1 \text{ mA}; V_{CE} = 1 \text{ V}; f = 1 \text{ GHz}$	–	2	–	dB

NPN 5 GHz wideband transistor

BFG25AW
BFG25AW/X; BFG25AW/XR

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

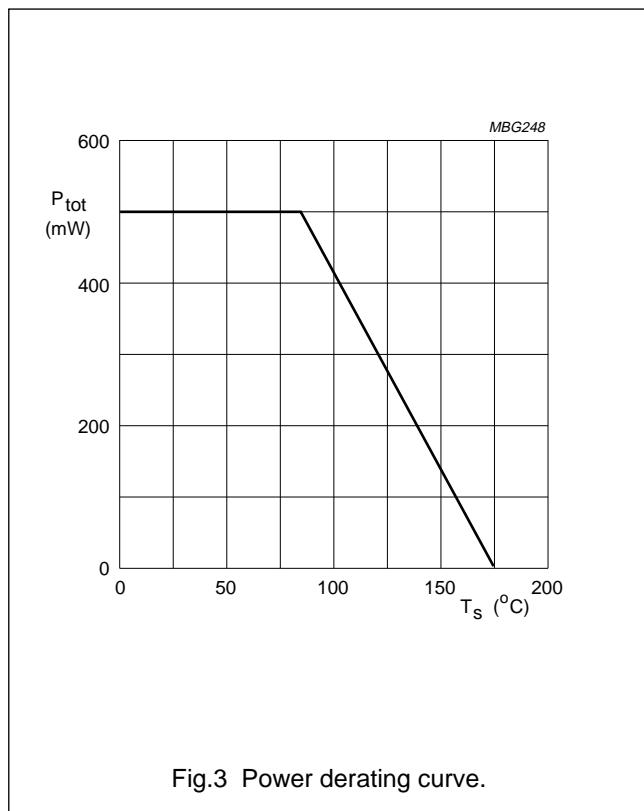
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	8	V
V_{CEO}	collector-emitter voltage	open base	–	5	V
V_{EBO}	emitter-base voltage	open collector	–	2	V
I_C	collector current (DC)		–	6.5	mA
P_{tot}	total power dissipation	up to $T_s = 85^\circ\text{C}$; see Fig.3; note 1	–	500	mW
T_{stg}	storage temperature		–65	+150	$^\circ\text{C}$
T_j	junction temperature		–	175	$^\circ\text{C}$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th j-s}$	thermal resistance from junction to soldering point	up to $T_s = 85^\circ\text{C}$; note 1	180	K/W

Note to the "Limiting values" and "Thermal characteristics"

1. T_s is the temperature at the soldering point of the collector pin.



NPN 5 GHz wideband transistor

BFG25AW
BFG25AW/X; BFG25AW/XR

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ (unless otherwise specified).

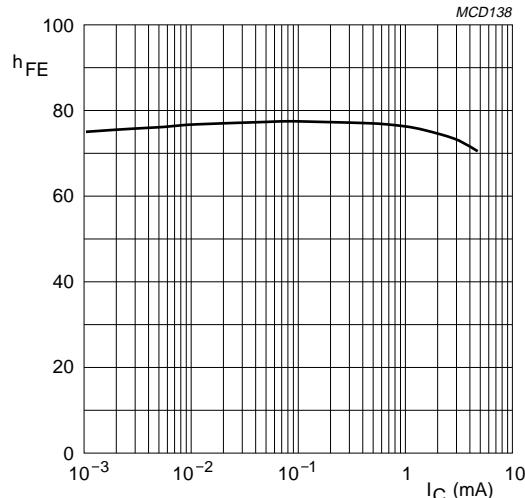
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(\text{BR})\text{CBO}}$	collector-base breakdown voltage	open emitter; $I_C = 100 \mu\text{A}$; $I_E = 0$	–	–	8	V
$V_{(\text{BR})\text{CEO}}$	collector-emitter breakdown voltage	open base; $I_C = 1 \text{ mA}$; $I_B = 0$	–	–	5	V
$V_{(\text{BR})\text{EBO}}$	emitter-base breakdown voltage	open collector; $I_E = 100 \mu\text{A}$; $I_C = 0$	–	–	2	V
I_{CBO}	collector cut-off current	open emitter; $V_{\text{CB}} = 5 \text{ V}$; $I_E = 0$	–	–	50	nA
h_{FE}	DC current gain	$I_C = 0.5 \text{ mA}$; $V_{\text{CE}} = 1 \text{ V}$	50	80	200	
C_{re}	feedback capacitance	$I_C = 0$; $V_{\text{CE}} = 1 \text{ V}$; $f = 1 \text{ MHz}$	–	0.2	0.3	pF
f_T	transition frequency	$I_C = 1 \text{ mA}$; $V_{\text{CE}} = 1 \text{ V}$; $f = 1 \text{ GHz}$; $T_{\text{amb}} = 25^\circ\text{C}$	3.5	5	–	GHz
G_{UM}	maximum unilateral power gain; note 1	$I_C = 0.5 \text{ mA}$; $V_{\text{CE}} = 1 \text{ V}$; $f = 1 \text{ GHz}$; $T_{\text{amb}} = 25^\circ\text{C}$	–	16	–	dB
		$I_C = 0.5 \text{ mA}$; $V_{\text{CE}} = 1 \text{ V}$; $f = 2 \text{ GHz}$; $T_{\text{amb}} = 25^\circ\text{C}$	–	8	–	dB
F	noise figure	$\Gamma_s = \Gamma_{\text{opt}}$; $I_C = 0.5 \text{ mA}$; $V_{\text{CE}} = 1 \text{ V}$; $f = 1 \text{ GHz}$	–	1.9	–	dB
		$\Gamma_s = \Gamma_{\text{opt}}$; $I_C = 1 \text{ mA}$; $V_{\text{CE}} = 1 \text{ V}$; $f = 1 \text{ GHz}$	–	2	–	dB

Note

1. G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero. $G_{\text{UM}} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)}$ dB.

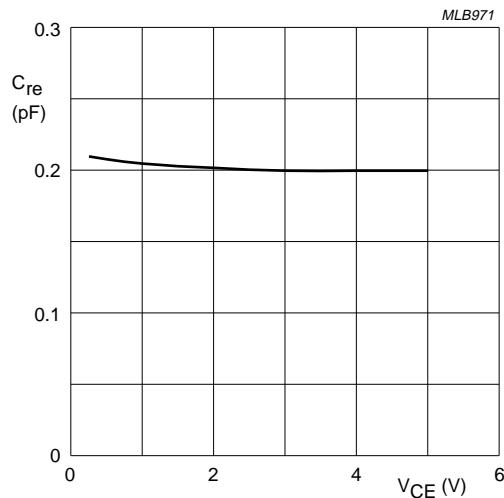
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BFG25AW/X; BFG25AW/XR



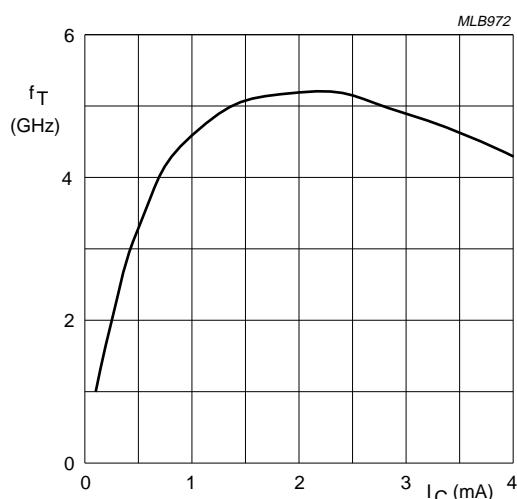
$V_{CE} = 1$ V.

Fig.4 DC current gain as a function of collector current; typical values.



$I_C = 0$; $f = 1$ MHz.

Fig.5 Feedback capacitance as a function of collector-base voltage; typical values.

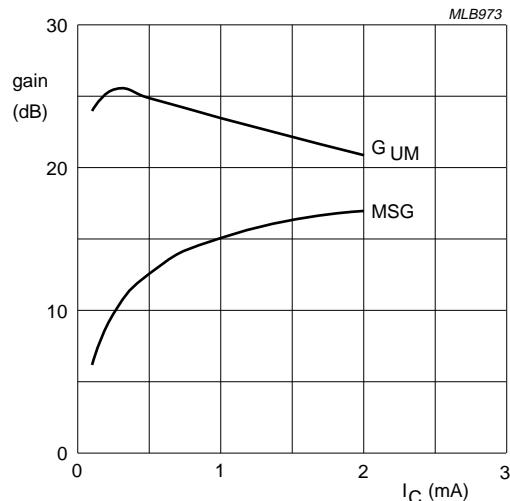


$f = 500$ MHz; $V_{CE} = 1$ V; $T_{amb} = 25$ °C.

Fig.6 Transition frequency as a function of collector current; typical values.

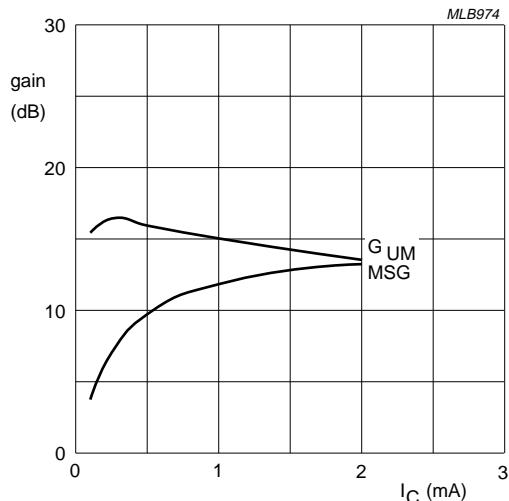
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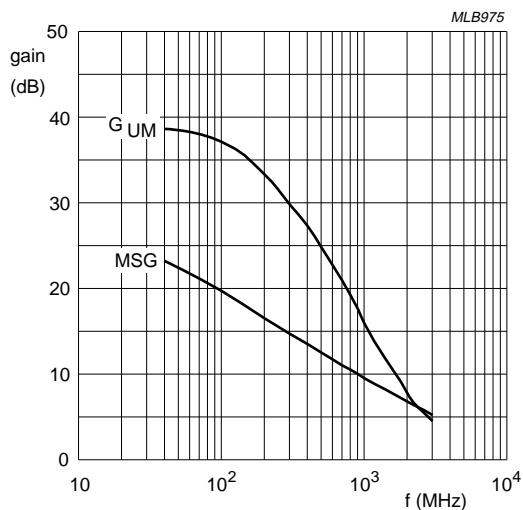
$f = 500 \text{ MHz}$; $V_{CE} = 1 \text{ V}$.

Fig.7 Gain as a function of collector current;
typical values.



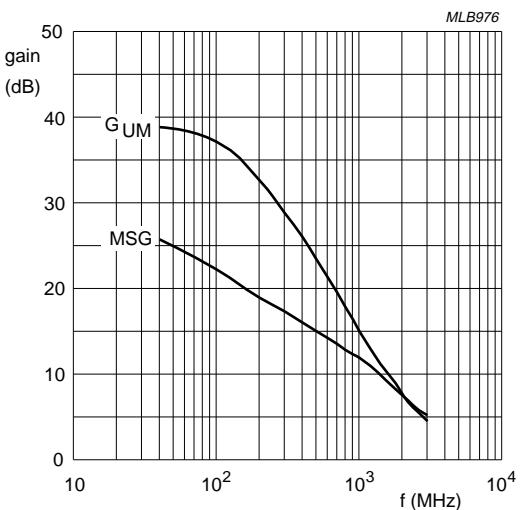
$f = 1 \text{ GHz}$; $V_{CE} = 1 \text{ V}$.

Fig.8 Gain as a function of collector current;
typical values.



$I_C = 0.5 \text{ mA}$; $V_{CE} = 1 \text{ V}$.

Fig.9 Gain as a function of frequency;
typical values.



$I_C = 1 \text{ mA}$; $V_{CE} = 1 \text{ V}$.

Fig.10 Gain as a function of frequency;
typical values.

NPN 5 GHz wideband transistor

BFG25AW

BFG25AW/X; BFG25AW/XR

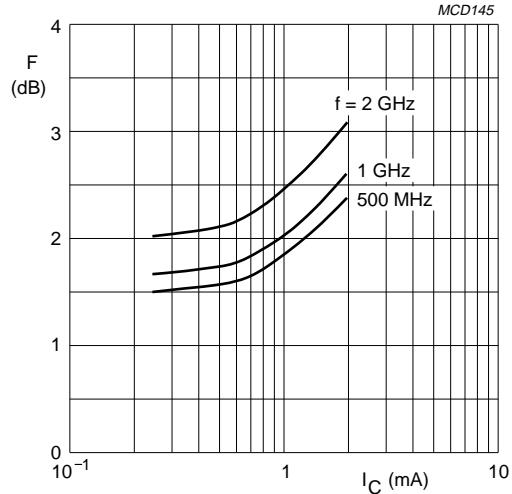
 $V_{CE} = 1 \text{ V}.$

Fig.11 Minimum noise figure as a function of collector current; typical values.

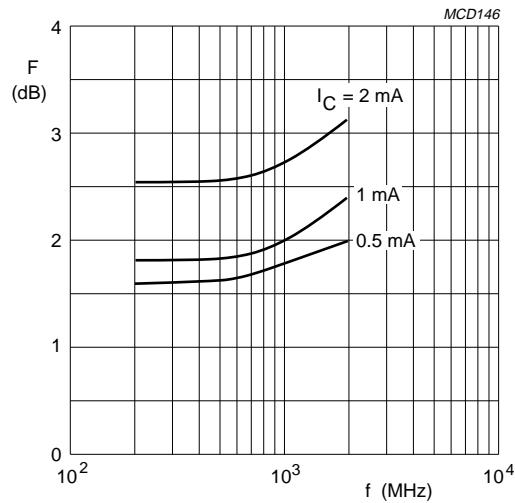
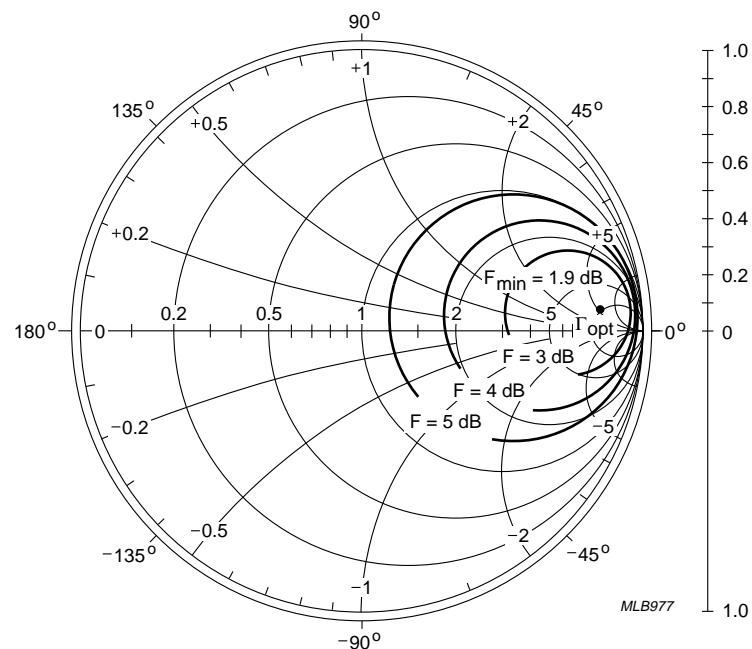
 $V_{CE} = 1 \text{ V}.$

Fig.12 Minimum noise figure as a function of frequency; typical values.

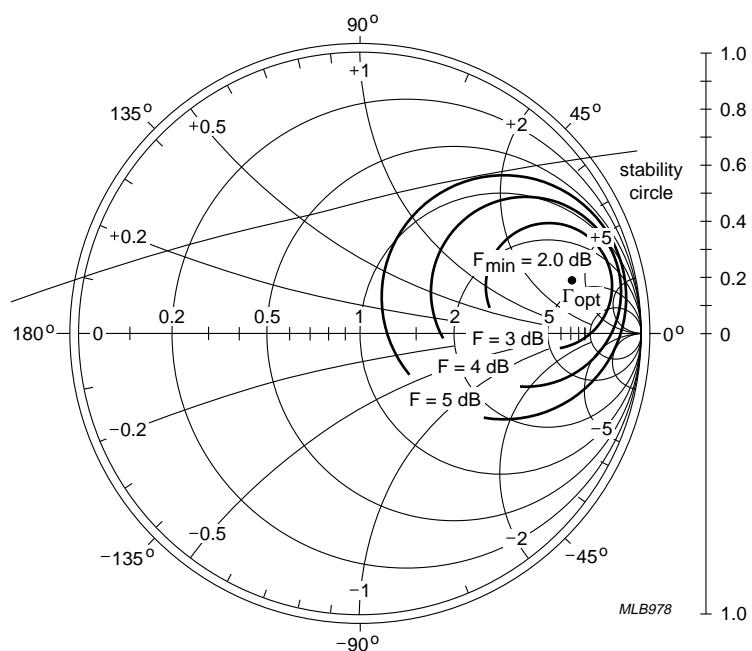
NPN 5 GHz wideband transistor

BFG25AW
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$f = 500 \text{ MHz}; V_{CE} = 1 \text{ V}; I_C = 1 \text{ mA}; Z_0 = 50 \Omega$.

Fig.13 Common emitter noise figure circles; typical values.



$f = 1 \text{ GHz}; V_{CE} = 1 \text{ V}; I_C = 1 \text{ mA}; Z_0 = 50 \Omega$.

Fig.14 Common emitter noise figure circles; typical values.

NPN 5 GHz wideband transistor

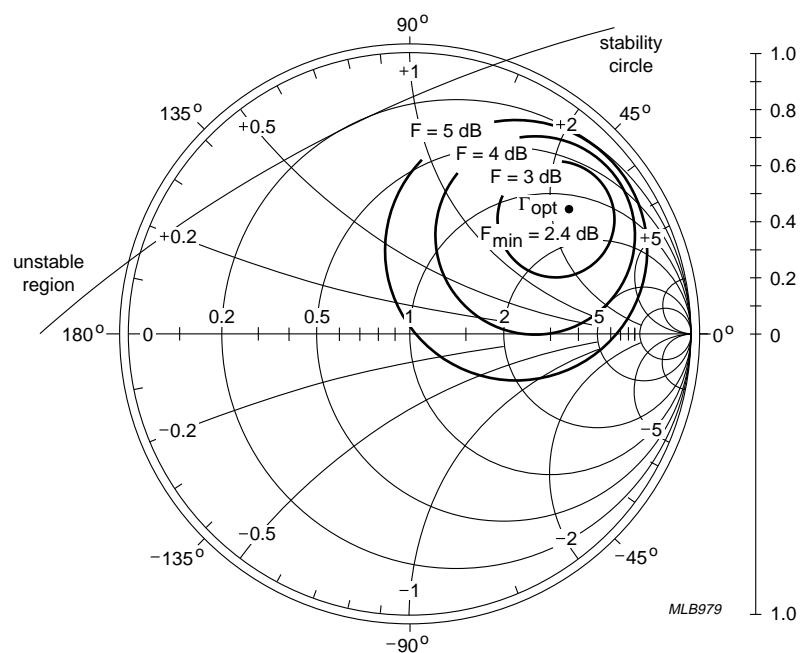
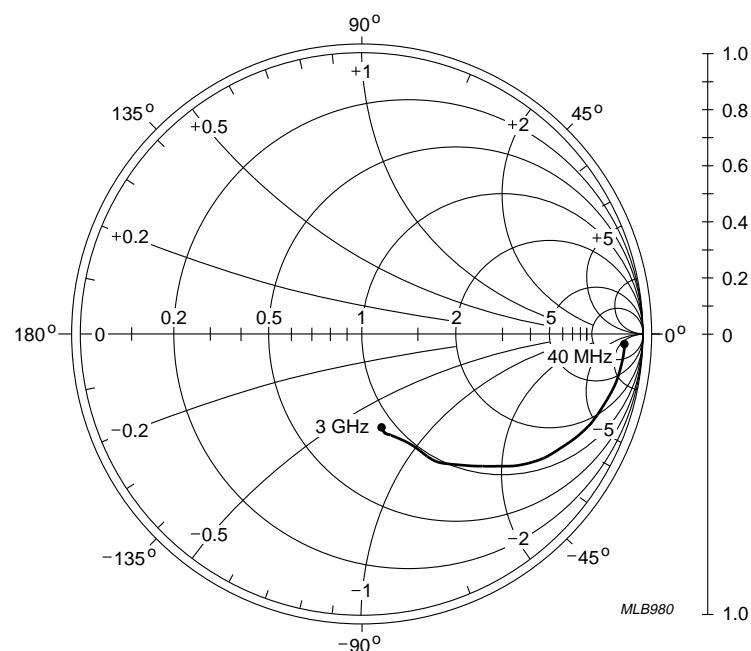
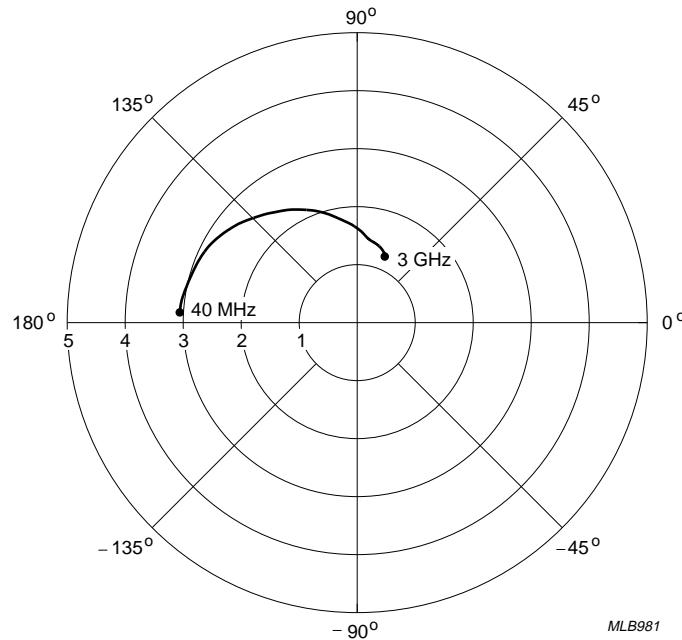
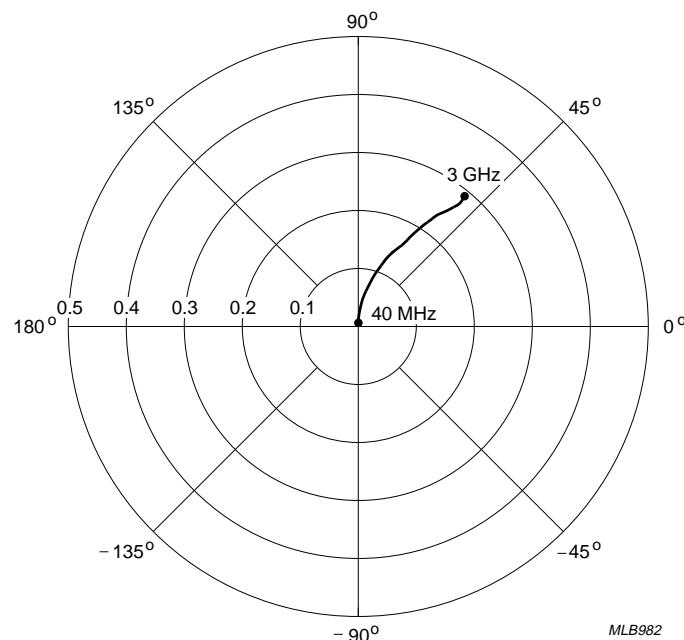
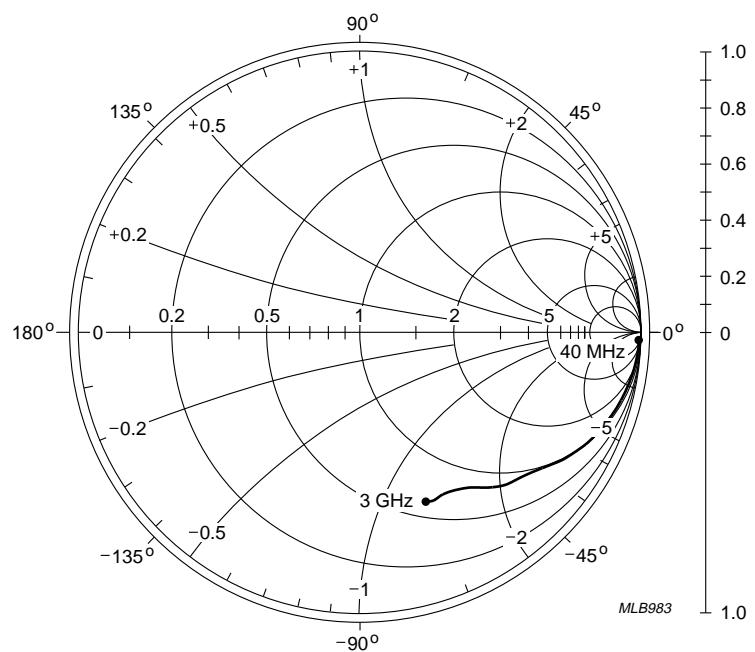
BFG25AW
BFG25AW/X; BFG25AW/XR $f = 2 \text{ GHz}; V_{CE} = 1 \text{ V}; I_C = 1 \text{ mA}; Z_o = 50 \Omega$.

Fig.15 Common emitter noise figure circles; typical values.

NPN 5 GHz wideband transistor

BFG25AW
BFG25AW/X; BFG25AW/XR $V_{CE} = 1 \text{ V}; I_C = 1 \text{ mA}; Z_0 = 50 \Omega.$ Fig.16 Common emitter input reflection coefficient (s_{11}); typical values. $V_{CE} = 1 \text{ V}; I_C = 1 \text{ mA}.$ Fig.17 Common emitter forward transmission coefficient (s_{21}); typical values.

NPN 5 GHz wideband transistor

BFG25AW
BFG25AW/X; BFG25AW/XR $V_{CE} = 1$ V; $I_C = 1$ mA.Fig.18 Common emitter reverse transmission coefficient (s_{12}); typical values. $V_{CE} = 1$ V; $I_C = 1$ mA; $Z_0 = 50 \Omega$.Fig.19 Common emitter output reflection coefficient (s_{22}); typical values.

NPN 5 GHz wideband transistor

BFG25AW
BFG25AW/X; BFG25AW/XR

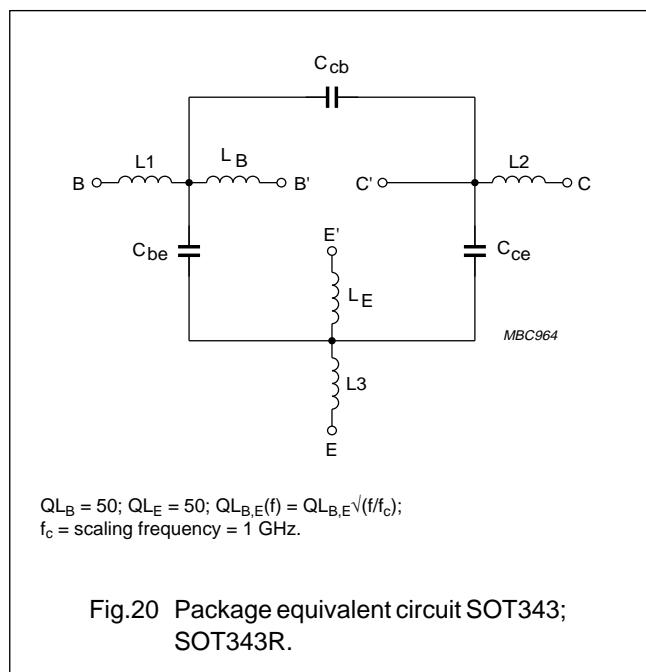
SPICE parameters for the BFG25W crystal

SEQUENCE No.	PARAMETER	VALUE	UNIT
1	IS	13.77	aA
2	BF	85.65	–
3	NF	0.980	–
4	VAF	50.80	V
5	IKF	10.00	A
6	ISE	2.199	fA
7	NE	1.857	–
8	BR	16.97	–
9	NR	0.986	–
10	VAR	2.491	V
11	IKR	188.0	mA
12	ISC	205.1	aA
13	NC	1.107	–
14	RB	80.00	Ω
15	IRB	1.000	μA
16	RBM	80.00	Ω
17	RE	7.911	Ω
18	RC	5.300	Ω
19 ⁽¹⁾	XTB	0.000	–
20 ⁽¹⁾	EG	1.110	eV
21 ⁽¹⁾	XTI	3.000	–
22	CJE	223.0	fF
23	VJE	669.7	mV
24	MJE	0.060	–
25	TF	5.112	ps
26	XTF	7.909	–
27	VTF	1.338	V
28	ITF	5.662	mA
29	PTF	15.37	deg
30	CJC	229.0	fF
31	VJC	394.7	mV
32	MJC	0.043	–
33	XCJC	0.050	–
34	TR	13.26	ns
35 ⁽¹⁾	CJS	0.000	F

SEQUENCE No.	PARAMETER	VALUE	UNIT
36 ⁽¹⁾	VJS	750.0	mV
37 ⁽¹⁾	MJS	0.000	–
38	FC	0.988	–

Note

- These parameters have not been extracted, the default values are shown.



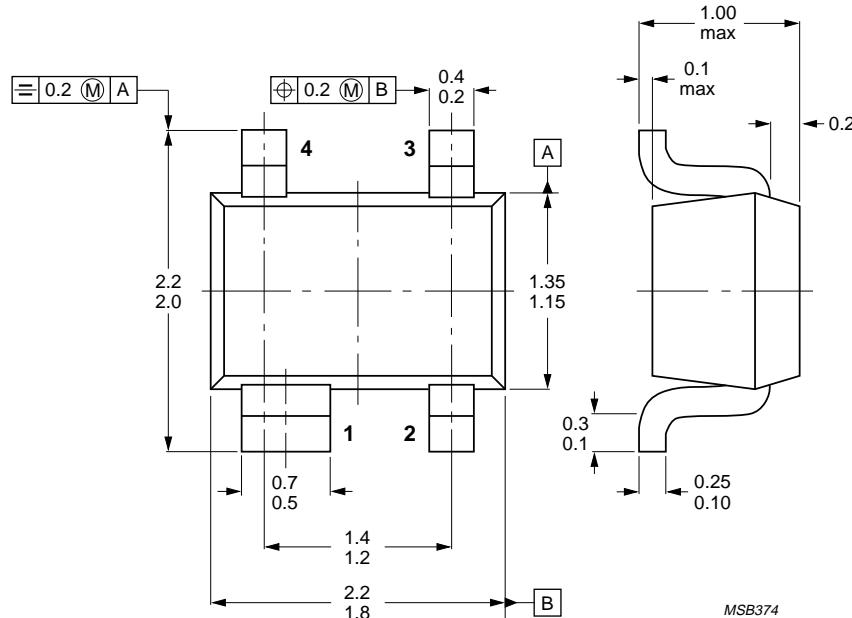
List of components (see Fig.20)

DESIGNATION	VALUE	UNIT
C_{be}	70	fF
C_{cb}	50	fF
C_{ce}	115	fF
L1	0.34	nH
L2	0.10	nH
L3	0.25	nH
L_B	0.40	nH
L_E	0.40	nH

NPN 5 GHz wideband transistor

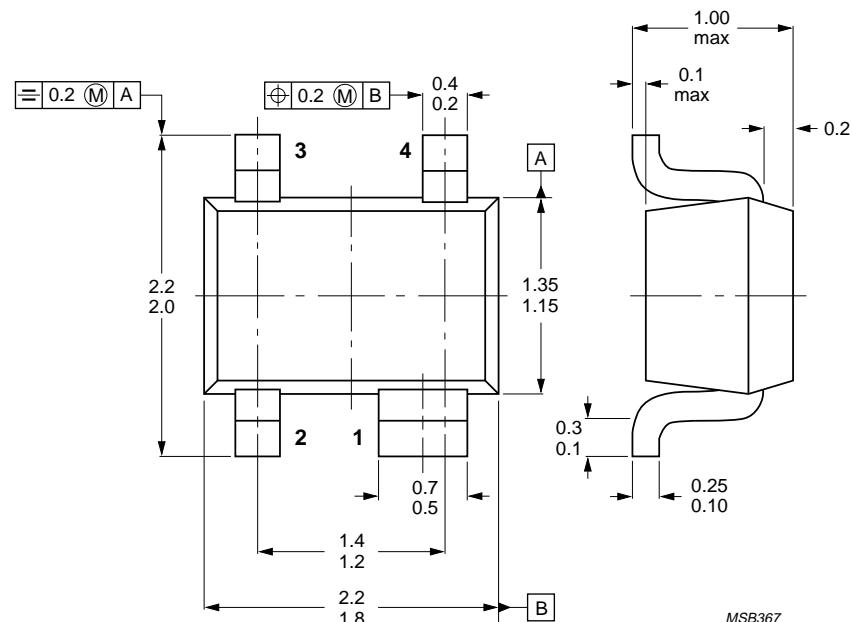
BFG25AW
BFG25AW/X; BFG25AW/XR

PACKAGE OUTLINES



Dimensions in mm.

Fig.21 SOT343.



Dimensions in mm.

Fig.22 SOT343R.

NPN 5 GHz wideband transistor**BFG25AW**
BFG25AW/X; BFG25AW/XR**DEFINITIONS**

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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BFG25AW
BFG25AW/X; BFG25AW/XR

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